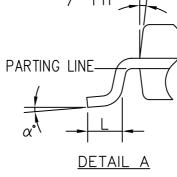


SEE DETAIL A



| DIMENSIONS IN INCHES |           |            |        |  |
|----------------------|-----------|------------|--------|--|
| SYMBOL               | MIN.      | NOM.       | MAX.   |  |
| А                    | 0.093     | 0.099      | 0.104  |  |
| A1                   | 0.004     | 0.008      | 0.012  |  |
| A2                   | 0.088     | 0.094      | 0.100  |  |
| В                    | 0.013     | 0.016      | 0.020  |  |
| С                    | 0.0090    | 0.0100     | 0.0125 |  |
| D                    | 0.599     | 0.606      | 0.613  |  |
| E                    | 0.292     | 0.296      | 0.299  |  |
| е                    | .050 BSC. |            |        |  |
| Н                    | 0.394     | 0.402      | 0.419  |  |
| h                    | 0.010     | 0.015      | 0.019  |  |
| L                    | 0.016     | 0.033      | 0.050  |  |
| α                    | 0*        | 5 <b>°</b> | 8*     |  |

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| DESCRIPTION:     | SOIC 24                   | PAGE 1 OF 2  |  |



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